WP4 Automated Precision Assembly Procedures

Lutz Feld *RWTH Aachen* Susanne Kühn *Uni Freiburg*

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From the proposal

- many modules needed (order 20'000 per exp.)
- double sided modules for L1 triggering need precise front-to-back alignment
- automated precision placement of sensors is needed everywhere
- explore assembly and QA procedures for single sided and back-to-back modules which allow high throughput and yield at the required accuracy
- deliverable will be a documentation of the developed procedures and possibly results from actual assembly exercises

	Aachen	Berlin	DESY	Freiburg	Hamburg	Karlsruhe
assembly procedures	Х	Х	Х	Х	Х	

Questions for today

- who is interested to work on this subject?
- what do ATLAS and CMS need?
- what are the subjects of common interest?
- which questions do we want to answer within this Alliance project?
- how do we organize the work?

THE CMS SIDE

Three Front-End ModuleTypes



3: VPS Modules

1: 2S Modules





Focus on '2S' modules



Why internal alignment matters

- pt is measured through offset of hits in two layers
 - ightarrow misalignment will cause systematic error on pt measurement
 - \rightarrow sign of error depends on charge sign of particle
 - \rightarrow trigger turn-on off-set from nominal, charge asymmetry
- internal misalignment cannot be corrected through track based alignment since hit correlation can only be shifted by multiples of pitch and it is unclear if re-programming of ASIC is possible / feasible
- systematic misalignment (e.g. due to assembly) will lead to global trigger charge asymmetry
 - \rightarrow offline cuts need to be hard enough (i.e. trigger is less selective)
- random misaligment will still lead to trigger inefficiency and trigger rate increase
- ightarrow requirements on internal module alignment should be well understood



pt measurement error



In natural units with B = 3.8T:

$$\rightarrow \qquad p_t [\text{GeV}] = \frac{cB}{10^9} \frac{\sqrt{r_1^2 + r_2^2 - 2r_1r_2\cos\Delta\varphi}}{2\sin\Delta\varphi}$$
$$\rightarrow \qquad p_t [\text{GeV}] \approx 0.57 \frac{\sqrt{r_1^2 + r_2^2 - 2r_1r_2\cos\Delta\varphi}}{\sin\Delta\varphi}$$

 $r_1 \approx r_2 \approx r \approx 0.5 \,\mathrm{m}$ $d = r_2 - r_1 \approx 1 \,\mathrm{mm}$ $\Delta x \approx \text{pitch} \approx 100 \,\mu\text{m}$ $\Delta \varphi \approx \frac{\Delta x}{r} \approx 2 \cdot 10^{-4}$ Approximations: $\sin \Delta \varphi \approx \Delta \varphi$ $\cos\Delta\varphi \approx 1$ $\Delta \varphi \approx \frac{\Delta x}{r}$ $\rightarrow p_t [\text{GeV}] \approx 0.57 \frac{\sqrt{r_1^2 + r_2^2 - 2r_1r_2}}{\Delta \varphi} = 0.57 \frac{d}{\Delta \varphi}$ p_t [GeV] $\approx 0.57 \frac{rd}{\Lambda r}$ Error on p_t measurement: r d

Required internal alignment accuracy

Error on p_t measurement:

$$\frac{\delta p_t}{p_t} \approx \frac{p_t \, [\text{GeV}]}{0.57 \, r \, d} \cdot \delta \left(\Delta x\right)$$

Using r = 0.5 m and d = 1 mm:

$$\rightarrow \frac{\delta p_t}{p_t} \approx \frac{p_t [\text{GeV}]}{285 \, \mu\text{m}} \cdot \delta(\Delta x)$$

Assuming pitch of 90 µm and binary read-out: $\delta(\Delta x) = \sqrt{2} \frac{90 \text{ µm}}{\sqrt{12}} = 37 \text{ µm}$

$$\rightarrow \quad \frac{\delta p_t}{p_t} \approx 0.13 \, p_t \, [\text{GeV}]$$

At $p_t = 2$ GeV we obtain 26% error of the p_t measurement - for perfect internal alignment.

At $p_t = 2$ GeV the displacement of the hits in the two layers is $\Delta x \approx 0.57 \frac{r d}{p_t} = 142.5 \ \mu\text{m} \approx 1.6 \times \text{pitch}$

An internal alignment off-set will cause a systematic shift of the p_t measurement. In order to limit the systematic shift to 10% we need an internal alignment accuracy of

$$\delta(\Delta x) \approx \frac{\delta p_t}{p_t} \frac{0.57 \, r \, d}{p_t \, [\text{GeV}]} = 14 \, \mu\text{m}$$

N.B.: this is not a gaussian sigma but a limit (may be taken to be 3σ)

 limit error on pt measurement to 10%
→ need an internal alignment accuracy about 14 µm (not a CMS spec!)



CMS Gantry Module Assembly







THE ATLAS SIDE

ATLAS Stave and Petal Concept



Prototyping and Alignment

Prototyping with focus on mass production:

Panel of hybrids



Test of stave assembly manually and with gantry



Alignment:

- Modules on Staves/Petals, two-sided and with up to 1 m length
- Staves/Petals on support structure
- Support structure itself

ATLAS SCT Endcap Modules



Figure 1.1. Exploded view of an SCT end-cap module showing the different components.

Manual production allows precision with tolerance of 5 μ m (out of 2380 modules)

SCT Barrel detectors were also assembled with module mounting robot for module-todisk assembly

Total yield in 2-years production (including 15 % spares) about 93 %



Conclusion on assembly accuracy

- 5 µm back-to-back accuracy is feasible with
 - elaborate and complex jigs
 - optical survey
 - transparent alignment marks
 - fixation of both sensors while glue cures
 - temperature control (aluminium: 23 μm/(m.K))
- gantry type assembly procedure
 - achieved accuracy on one side: 20-30 μm
 - back-to-back accuray will at best be slightly worse

Subjects of common interest

- precise automated placement of sensors
 - lessons from the past
 - which procedures have been followed?
 - what precision has been reached?
 - what where the dominant error sources?
 - what assembly speed has been achieved?
 - current plans for ATLAS and CMS
 - open issues
- gluing procedures, choice of glue, co-curing
- metrology (module alignment, front-to-back?)
- rework procedures
- options for mass/automated production
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